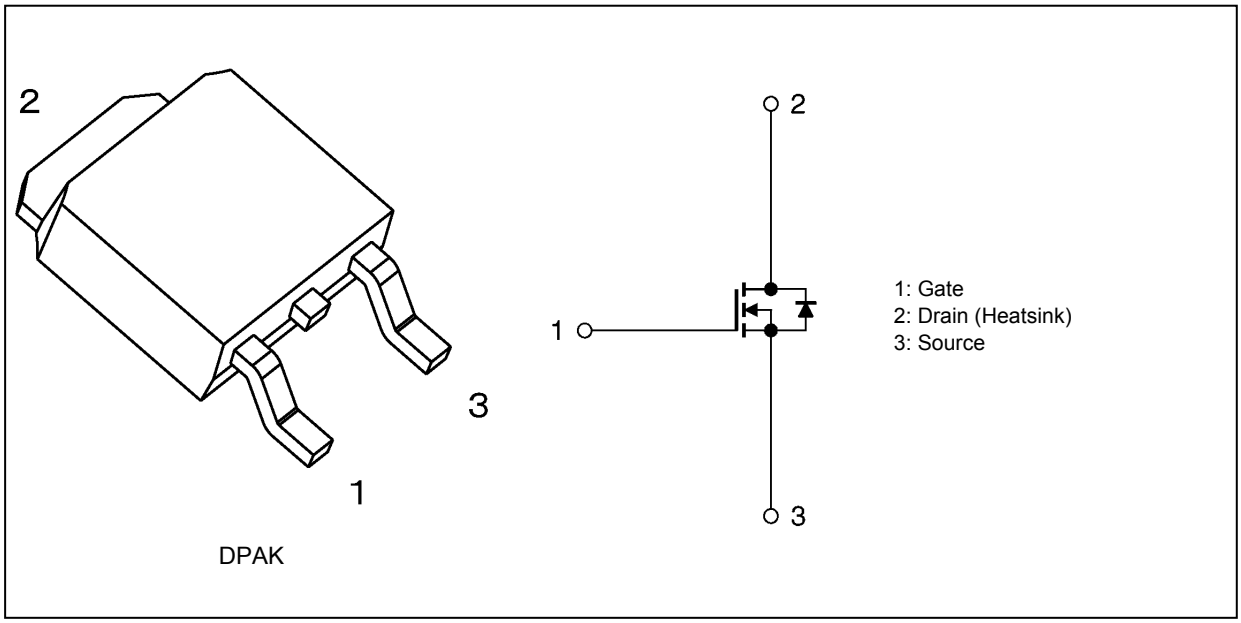
1. Applications

- Switching Voltage Regulators

2. Features

(1) Low drain-source on-resistance: $R_{DS(ON)}$ = 0.327 Ω (typ.)
by used to Super Junction Structure : DTMOS
(2) Easy to control Gate switching
(3) Enhancement mode: V_{th} = 2.7 to 3.7 V (V_{DS} = 10 V, I_D = 0.5 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	600	V
Gate-source voltage		V_{GSS}	±30	
Drain current (DC)	(Note 1)	I_D	9.7	A
Drain current (pulsed)	(Note 1)	I_{DP}	38.8	
Power dissipation	(T_c = 25°C)	P_D	80	W
Single-pulse avalanche energy	(Note 2)	E_{AS}	121	mJ
Avalanche current		I_{AR}	2.5	A
Reverse drain current (DC)	(Note 1)	I_{DR}	9.7	
Reverse drain current (pulsed)	(Note 1)	I_{DRP}	38.8	
Channel temperature		T_{ch}	150	°C
Storage temperature		T_{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	1.57	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.
Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 33.9 mH, R_G = 25 Ω, I_{AR} = 2.5 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

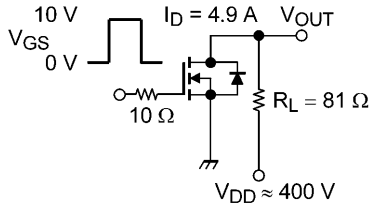
6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	—	—	±1	μA
Drain cut-off current	I_{DSS}	V_{DS} = 600 V, V_{GS} = 0 V	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	I_D = 10 mA, V_{GS} = 0 V	600	—	—	V
Gate threshold voltage	V_{th}	V_{DS} = 10 V, I_D = 0.5 mA	2.7	—	3.7	
Drain-source on-resistance	$R_{DS(ON)}$	V_{GS} = 10 V, I_D = 4.9 A	—	0.327	0.43	Ω

6.2. Dynamic Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	V_{DS} = 300 V, V_{GS} = 0 V, f = 1 MHz	—	700	—	pF
Reverse transfer capacitance	C_{rss}		—	2.3	—	
Output capacitance	C_{oss}		—	20	—	
Effective output capacitance	$C_{o(er)}$	V_{DS} = 0 to 400 V, V_{GS} = 0 V	—	35	—	
Gate resistance	r_g	V_{DS} = OPEN, f = 1 MHz	—	7.5	—	Ω
Switching time (rise time)	t_r	See Figure 6.2.1	—	22	—	ns
Switching time (turn-on time)	t_{on}		—	45	—	
Switching time (fall time)	t_f		—	5.5	—	
Switching time (turn-off time)	t_{off}		—	75	—	
MOSFET dv/dt ruggedness	dv/dt	V_{DD} = 0 to 400 V, I_D = 4.9 A	50	—	—	V/ns



Duty ≤ 1%, t_w = 10 μs

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	V_{DD} ≈ 400 V, V_{GS} = 10 V, I_D = 9.7 A	—	20	—	nC
Gate-source charge 1	Q_{gs1}		—	4.5	—	
Gate-drain charge	Q_{gd}		—	9.5	—	

6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage	V_{DSF}	I_{DR} = 9.7 A, V_{GS} = 0 V	—	—	-1.7	V
Reverse recovery time	t_{rr}	I_{DR} = 4.9 A, V_{GS} = 0 V $-dI_{DR}/dt$ = 100 A/μs	—	250	—	ns
Reverse recovery charge	Q_{rr}		—	2.2	—	μC
Peak reverse recovery current	I_{rr}		—	19	—	A
Diode dv/dt ruggedness	dv/dt	I_{DR} = 4.9 A, V_{GS} = 0 V, V_{DD} = 400 V	15	—	—	V/ns

7. Marking

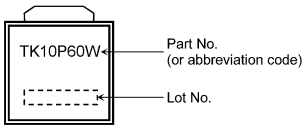


Fig. 7.1 Marking

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8. Characteristics Curves (Note)

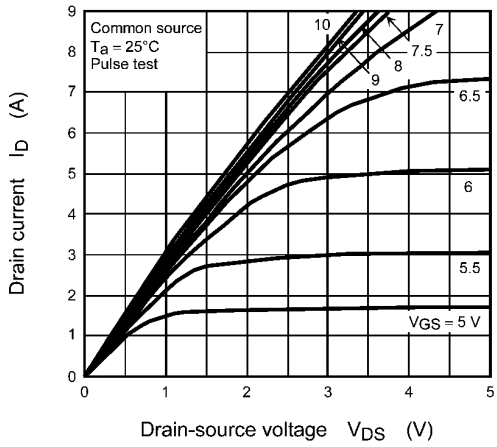

Fig. 8.1 I_D - V_{DS}

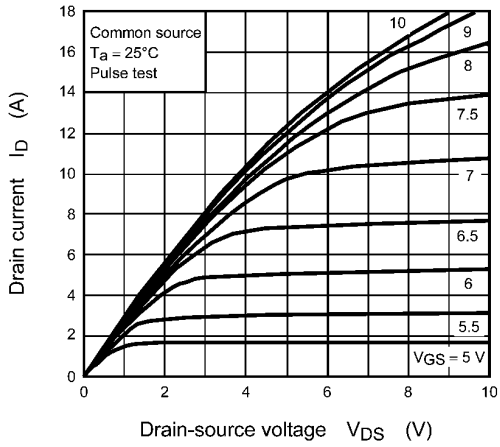

Fig. 8.2 I_D - V_{DS}

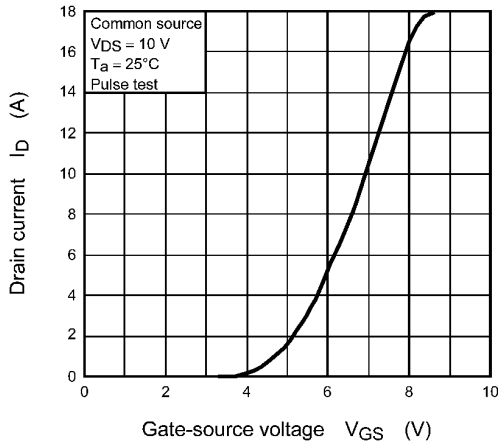

Fig. 8.3 I_D - V_{GS}

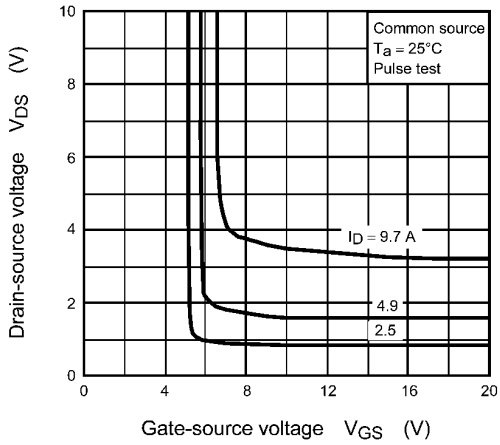

Fig. 8.4 V_{DS} - V_{GS}

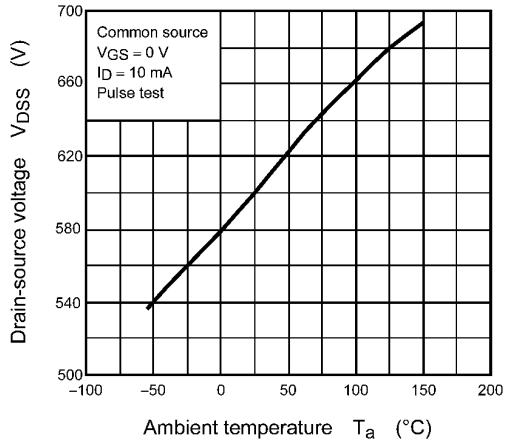

Fig. 8.5 V_{DSS} - T_a

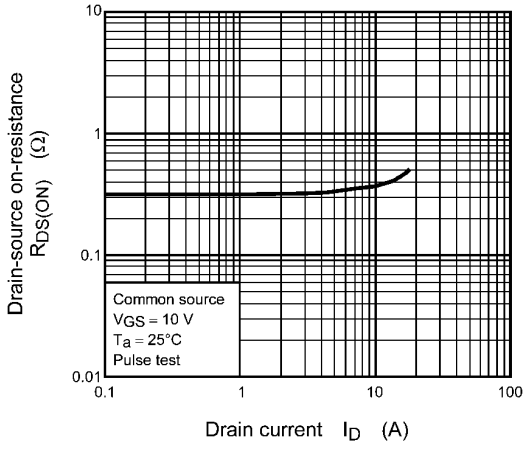

Fig. 8.6 $R_{DS(ON)}$ - I_D

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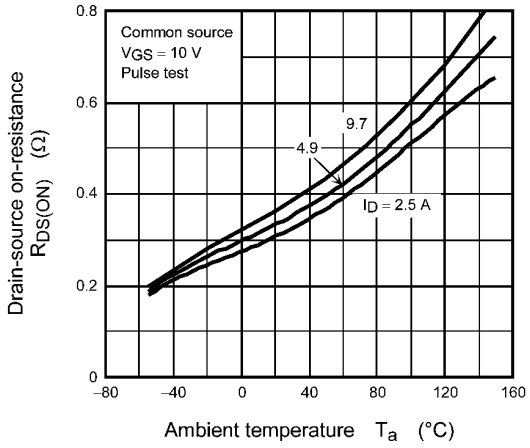

Fig. 8.7 $R_{DS(ON)}$ - T_a

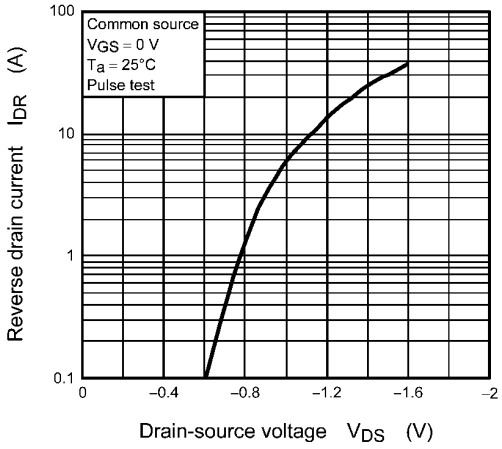

Fig. 8.8 I_{DR} - V_{DS}

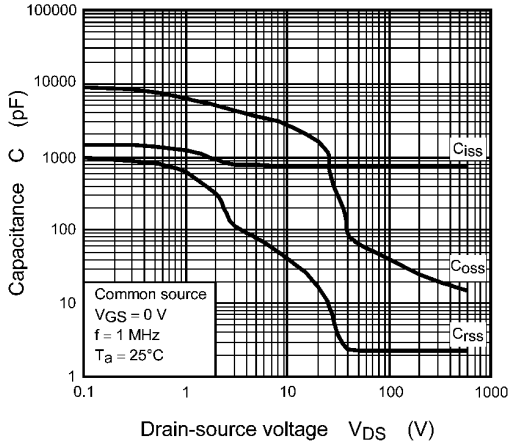

Fig. 8.9 C - V_{DS}

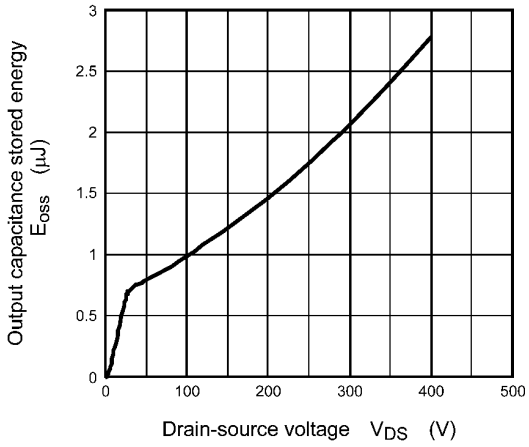

Fig. 8.10 E_{OSS} - V_{DS}

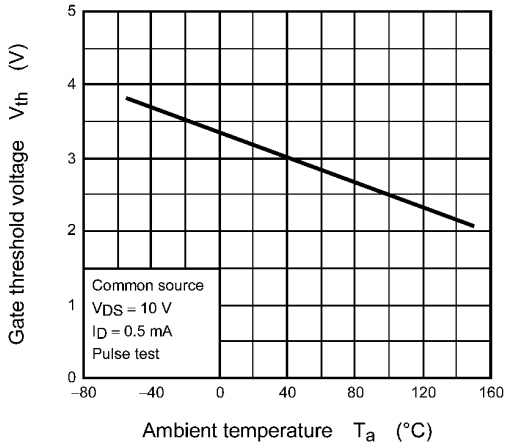

Fig. 8.11 V_{th} - T_a

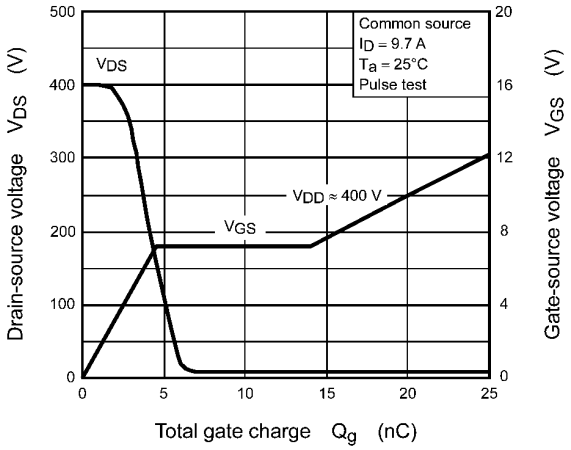

Fig. 8.12 Dynamic Input/Output Characteristics

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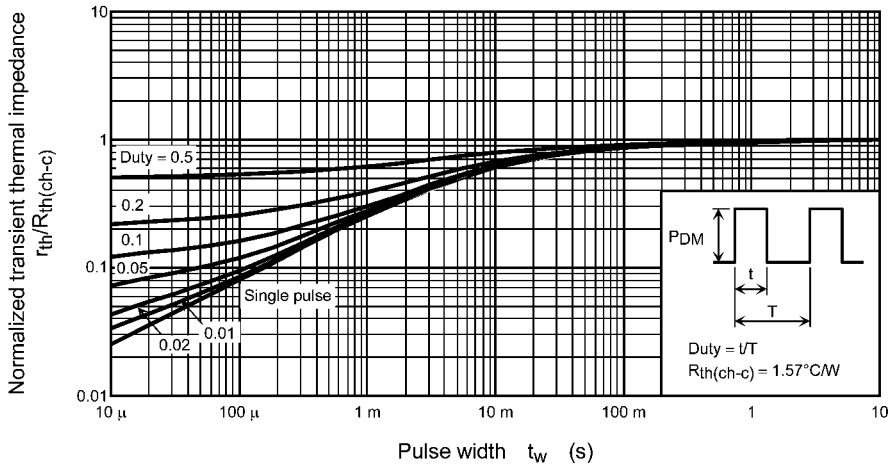


Fig. 8.13 r_{th} - t_w
(Guaranteed Maximum)

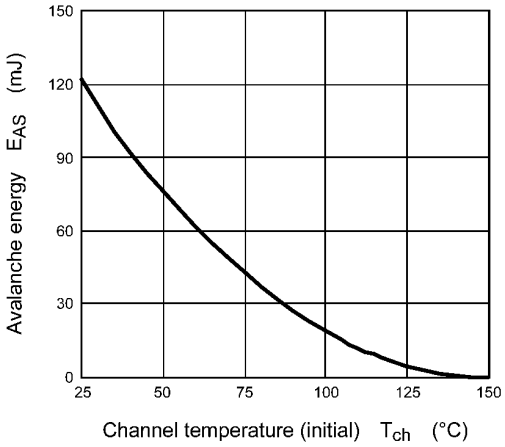


Fig. 8.14 E_{AS} - T_{ch}
(Guaranteed Maximum)

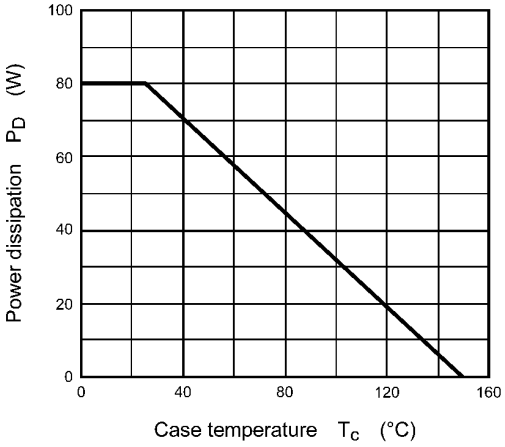
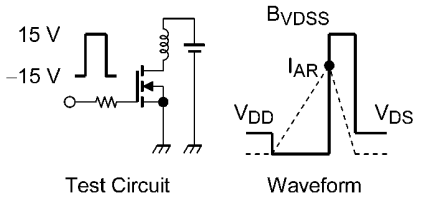


Fig. 8.15 P_D - T_c
(Guaranteed Maximum)



$R_G = 25\ \Omega$, $V_{DD} = 90$ V $E_{AS} = \frac{1}{2} \cdot L \cdot I^2_{AR} \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$

Fig. 8.16 Test Circuit/Waveform

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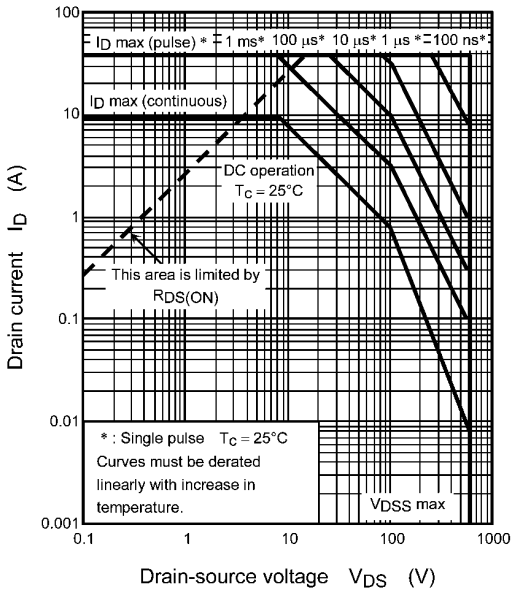
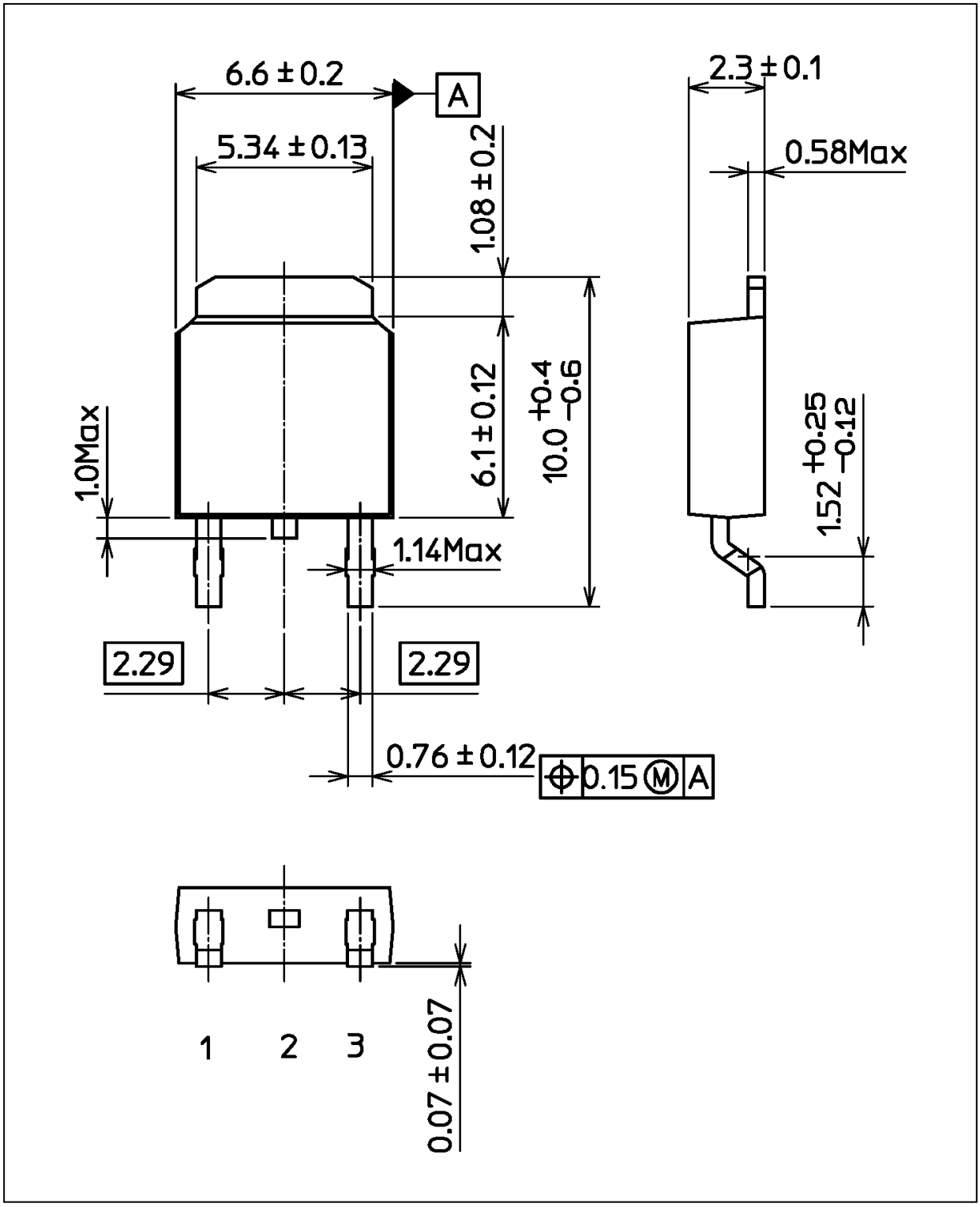


Fig. 8.17 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



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